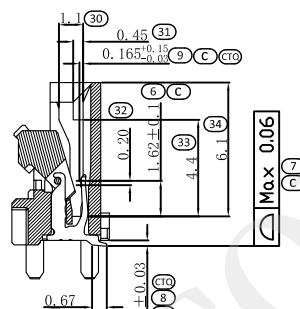
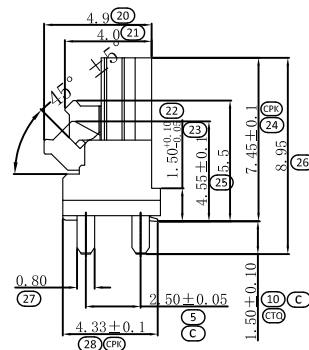
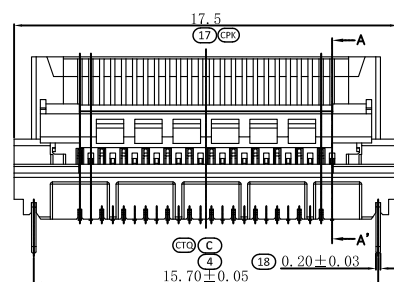
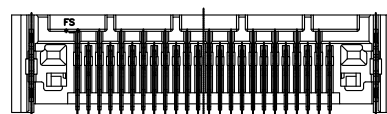
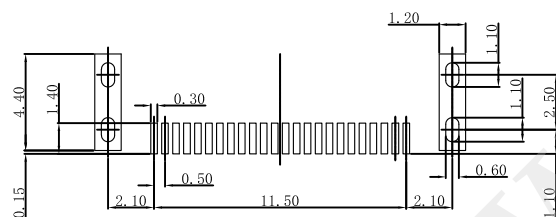
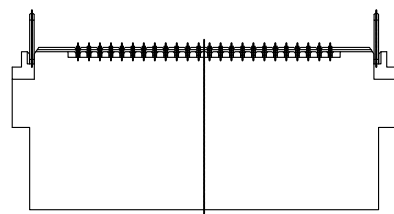


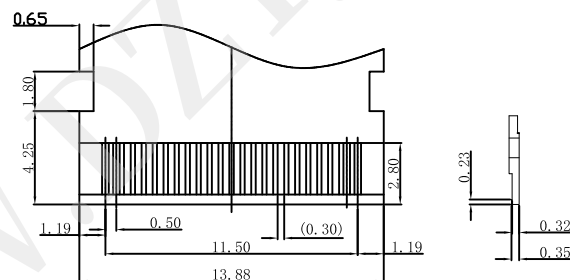
SECTION A-A
ACT CLOSE



SECTION A-A
ACT OPEN



PCB PATTERN LAYOUT



NOTES:

1. MATERIAL:

HOUSING: LCP, UL 94V-0, NATURAL;

CONTACT 1: COPPER ALLOY, T=0.15mm.

CONTACT 2: COPPER ALLOY, T=0.15mm.

FITTING NAIL :C2680 T=0.20mm.

2. PLATING:

TERMINAL - CONTACT AREA: Au 0.1um Min OVER NI 2~5um,

- N/B AREA:

- SMD AREA: Au FLASH 0.05um Min OVER NI 2~5um,

FITTING NAIL:Sn 3~5um"Min,OVER NI 2~5 um.

$\odot$ IS FAI SIZE.

(c) IS FIRST INSPECTION SIZE.

(CTQ) IS INSPECTION SIZE.

(CPK) IS CPK SIZE.



深圳市华宇创精密电子有限公司

TOLERANCE:		DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME: 0.5PH 7.45H 24P 立贴掀盖带扣FP	
X.X ±0.30	X.XX ±0.25				
X.XXX ±0.15		CHECKED BY: 马跃	DATE : 2014-02-23	PART NO.	HYCHE4-05FPC24-745
X.* ±2*	X.X* ±0.5*			MOLD NO.	
		APPROVED BY: 邱敏	DATE : 2014-02-23	DRAW NO:	HYC-2609231553
UNIT: mm [inch]				SHEET NO.	1 OF 1
SCALE:1:1	SIZE: A4				